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75	90 12/13/2002			
ARTHUR R. CRAWFORD			EXAMINER	
NIXON & VANDERHYE P.C. 8TH FLOOR			BAUMEISTER, BRADLEY W	
1100 NORTH GLEBE ROAD ARLINGTON, VA 22201-4714			ART UNIT	PAPER NUMBER
,			2815	
			DATE MAILED: 12/13/2002	

Please find below and/or attached an Office communication concerning this application or proceeding.

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# Office Action Summary

Application No. 09/463,643

Applicant(s)

Nakamure et al.

Examiner

B. Williem Baumeistar

Art Unit 2815



The MAILING DATE of this communication appears	n the cover sheet with the correspondence address				
Period for Reply	TO THE TOTAL OF TH				
A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE MONTH(S) FROM THE MAILING DATE OF THIS COMMUNICATION.  • Extensions of time may be eveilable under the provisione of 37 CFR 1.136 (e). In no event, however, may e reply be timely filed after SIX (6) MONTHS from the					
mailing date of this communication.  If the period for reply specified ebove is less than thirty (30) days, a reply within the lift NO period for reply is specified ebove, the meximum statutory period will epply a Feilure to reply within the sat or extended period for reply will, by statute, cause the Any reply received by the Office later than three months efter the mailing date of the semed patent term edjustment. See 37 CFR 1.704(b).	e statutory minimum of thirty (30) days will be considered timely.  Id will expire SIX (6) MONTHS from the meiling date of this communication.  If application to become ABANDONED (35 U.S.C. § 133).				
Status					
1) Responsive to communication(s) filed on Oct 4, 20					
2a) ☑ This action is FINAL. 2b) ☐ This act	on is non-final.				
3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11; 453 O.G. 213.					
Disposition of Claims					
4) 💢 Claim(s) <u>31-47</u>	is/are pending in the application.				
4a) Of the above, claim(s)	is/are withdrawn from consideration.				
5)  Claim(s)	is/are allowed.				
6) 💢 Claim(s) 31-47	is/are rejected.				
7) Claim(s)					
	are subject to restriction and/or election requirement.				
Application Pepers					
9) The specification is objected to by the Examiner.					
10) The drewing(s) filed on is/are	a) $\square$ accepted or b) $\square$ objected to by the Examiner.				
Applicant may not request that any objection to the drawing(s) be held in ebeyance. See 37 CFR 1.85(a).					
	is: a) $\square$ approved b) $\square$ disapproved by the Examiner				
If approved, corrected drawings are required in reply to this Office action.					
12) The oath or declaration is objected to by the Exam	ner.				
Priority under 35 U.S.C. §§ 119 and 120					
13) Acknowledgement is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).					
a) 🗆 All b) 🗀 Some* c) 🗖 None of:					
1. Certified copies of the priority documents have	e been received.				
2. Certified copies of the priority documents have been received in Application No.					
application from the International Bure					
*See the attached detailed Office action for a list of the					
14) Acknowledgement is made of a claim for domestic priority under 35 U.S.C. § 119(e).					
a) The translation of the foreign language provisional application has been received.  15) Acknowledgement is made of a claim for domestic priority under 35 U.S.C. §§ 120 and/or 121.					
Attachment(s   1  Notice of References Cited (PTO-892)	4) Interview Summery (PTO-413) Paper No(s).				
2) Notice of Dreftsperson's Patent Drewing Review (PTO-948)	5) Notice of Informel Patent Application (PTO-152)				
31 Information Disclosure Statement(s) (PTO-1449I Paper No(s).	6) Other:				

Application/Control Number: 09/463,643 Page 2

Art Unit: 2815

#### DETAILED ACTION

### Claim Rejections - 35 USC § 102

1. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (e) the invention was described in-
- (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effect under this subsection of a national application published under section 122(b) only if the international application designating the United States was published under Article 21(2)(a) of such treaty in the English language; or
- (2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that a patent shall not be deemed filed in the United States for the purposes of this subsection based on the filing of an international application filed under the treaty defined in section 351(a).
- 2. Claims 31-37, 39-41, 43-45 are rejected under 35 U.S.C. 102(e) as being anticipated by Itaya et al. '017 (previously made of record). Itaya discloses various embodiments of nitride-based light emitters having a p-active-n structure, and optional features that may be employed in various embodiments.
- a. Regarding claims 31, 33-36, 39, 40 and 43-45, note e.g., embodiment 2 depicted in Fig 8D as modified by undepicted embodiment 4 wherein an additional undoped GaN layer (constituting the first layer) is interposed between the low temperature 40 nm GaN buffer (LT-GaN) 502 and the 4 micron n-doped GaN layer 503 (col. 16, lines 33-). Either GaN layer 503, AlGaN layer 504 or alternatively the combination of both of layers 503 and 504 can be labeled as Applicant's second layer. Undoped, 0.1 micron GaN layer 505 constitutes the third layer. Claim

Art Unit: 2815

45 is anticipated under the interpretation that the combination of layers 503 and 504 constitutes Applicant's claimed second layer.

- b. Regarding claims 35-37 and 45, note embodiment 9 depicted in FIG 16. The n-active-p laser diode includes the following three-layer laminated structure on a substrate 11: a first layer of 0.3-micron, undoped GaN 13; a second layer of 1.5 micron, 1e18-doped Si-AlGaN 14; and a third layer of 0.2 micron 5e17-doped Si-AlGaN. These layers are formed on a 30-nm LT-GaN buffer 12 that is interposed between the first layer and the substrate.
- c. Regarding claims 31-35, 39, 41 and 43-45, note embodiment 5 as depicted in FIGs. 10 and 11 and embodiment 6 which modifies FIG 10 as depicted in Fig 12. Undoped LT-GaN layer 102 constitutes the first layer; either of 3-micron n-GaN layer 103 and/or 0.25 micron n-AlGaN layer 105 constitutes the second layer; 0.1-micron undoped (In)GaN optical guide 106a constitutes the third layer; and the MQB region of the plurality of layers jointly labeled as 106 reads on the active layer, as claimed. The optical guide may be composed of u-GaN (FIG 11) or alternatively InGaN (FIG 12).
- 3. Claims 31-37, 39, 41 and 43-45 are rejected under 35 U.S.C. 102(e) as being anticipated by or, in the alternative, under 35 U.S.C. 103(a) as obvious over Itaya et al. '017 (previously made of record) as applied to the claims above.
- a. Regarding claims 32 and 37 and the above-stated rejection based on embodiment 2 depicted in Fig 8D as modified by embodiment 4 (see paragraph 2a), the disclosure in relation to

Art Unit: 2815

embodiment 4 does not set forth any particular thickness for the undoped GaN layer that is interposed between the 40-nm GaN buffer 502 and the 4-micron n-GaN second layer 503. As such, this portion of the disclosure does not expressly state that the first layer is "thin" as set forth in claim 32 (interpreted to mean that the first layer is thinner than the second, "thick" layer), nor that the first layer is thicker than the 40-nm buffer 502 as set forth in claim 37. Nonetheless, Itaya teaches in relation to embodiment 9, depicted in FIG 16, that a high temperature, undoped GaN (u-GaN) buffer layer 13 is interposed between a 30-nm low-temperature GaN buffer 12 and 1.5micron n-AlGaN contact layer 14 for the purpose of improving crystallinity (e.g., cols. 21-22), the same purpose as the inclusion of the undepicted u-GaN layer in embodiment 4. Thus, one skilled in the art would have understood that the thickness of the u-GaN buffer layer of embodiment 4 would also have a thickness that is on this order of magnitude and therefore the claims are anticipated. Alternatively, assuming arguendo that the reference must be interpreted so narrowly as not sufficiently disclosing this fact so as to constitute a basis for an anticipation rejection, it nonetheless would have been obvious to one of ordinary skill in the art at the time of the invention to have formed the u-GaN layer of embodiment 4 to have a thickness that is on the same order of magnitude as that of the u-GaN layer 13 of embodiment 9 since they are both disposed in the same relative position and both perform the same function.

Regarding claims 36 and 37 and the above-rejection based on embodiment 5 b. depicted in Figs 10-12 (see paragraph 2c), the disclosure does not expressly state that an additional u-GaN layer (such as set forth in relation to embodiment 4 and 9) may be interposed

Art Unit: 2815

between the LT-GaN buffer 102 and the n-GaN contact 103. Nonetheless because the reference teaches that this feature may optionally be employed in various embodiments, one skilled in the art would have understood that the reference either implicitly teaches that this feature may also be employed in the embodiments of FIGs 10-12 (anticipation rejection), or alternatively, it would have at least been obvious to the skilled artisan to have so employed this layer in these embodiments for the reasons set forth above (obviousness rejection).

Regarding claims 31-37, 39, 41 and 43-45, note embodiment 10 as depicted in FIG 19 wherein an LD comprises a first layer of 0.3 micron HT-GaN formed on a 30-nm LT-GaN buffer. A 500-nm, (Al)GaN superlattice 24, either alone or alternatively in combination with n-AlGaN layer(s) 23 and/or 25 constitutes the second layer. Itaya discloses that this superlattice structure produces a 2DEG that lowers the contact resistance (col. 24, lines 41-52). The portion of the disclosure relating to embodiment 10 further sets forth a MQW active region 26, but unlike embodiment 5 of Fig 10, does not expressly set forth the presence of an n-side, undoped (In)GaN optical guide layer that would read on the third layer. Under an interpretation that the reference implies that an optical guide layer, as taught by embodiment 5, could also be employed in the tenth embodiment of Fig 19, the claims would be anticipated. This interpretation is supported by the fact that, just like the fifth embodiment, the tenth embodiment is also directed towards a laser diode, so the presence of an optical guide layer would be highly beneficial if not necessary to sufficiently confine light in the active region. Alternatively, under a more narrow interpretation that such a combination of embodiments is not at least implied, the inclusion of an u-(In)GaN

Art Unit: 2815

optical guide layer as taught by the fifth and sixth embodiments in the tenth embodiment would have been obvious at least for this stated reason.

- 4. Claims 31-39 and 41-47 are rejected under 35 U.S.C. 103(a) as being unpatentable over Itaya as applied to the claims immediately above in relation to the tenth embodiment of Fig 19, and further in view of Bruno '604 (previously made of record). Itaya teaches the employment of a doped (Al)GaN superlattice for injecting current to the active layer at low resistance by a pseudo two-dimensional electron gas (col. 24, lines 48-52). Itaya does not teach that the superlattice may include undoped wells.
- a. Bruno teaches that (Al)GaN superlattices can be modulation-doped such that the dopant atoms are restricted to the barrier layers (col. 2, lines 59-60)--i.e., the GaN wells are undoped--for the purpose of reducing scattering and increasing mobility. It would have been obvious to one of ordinary skill in the art at the time of the invention to have provided a mod-doped superlattice for the superlattice 24 in the light emitter of Itaya for the purpose of reducing scattering and increasing mobility/reducing resistance as taught by Bruno.
- b. As such, depending upon the specific claims, either the 30 nm u-LT-AlGaN layer 22 and/or the .3 micron u-HT-GaN reads on the first layer. And the mod-doped superlattice 24, either alone or in combination with the n-AlGaN layer(s) 23 and/or 25 reads on the second layer.
- i. Further, under one interpretation, the (In)GaN optical guide layer 106a of the fifth and sixth embodiments reads on the third layer.

Page 7

Application/Control Number: 09/463,643

Art Unit: 2815

- ii. Under an alternative interpretation, the uppermost well of the superlattice (a 50-angstrom u-GaN layer) reads on the third layer. As such, the n-AlGaN layer 25 reads on the limitation of claims 38 and 42 that requires the further presence of an n-clad, or an AlN-based layer, respectively, interposed between the 3rd layer and the active layer.
- iii. Claim 42 further requires that the third layer, on which the AIN-based layer is formed, be composed of InGaN, and as such, the uppermost u-GaN well of Itaya/Bruno does not read on this limitation when interpreted as constituting the third layer. Nonetheless, it was well known to those of ordinary skill in the art at the time of the invention that InGaN has a smaller bandgap than GaN, and it was known by those skilled in the art how to form a (AI)GaN-barrier/InGaN-well superlattice. It would have been obvious to one of ordinary skill in the art at the time of the invention to have composed the mod-doped superlattice 24 of Itaya/Bruno with u-InGaN instead of u-GaN for the purpose of further improving upon the pseudo two-dimensional electron gas effects of the superlattice: reducing the well's effective bandgap to increase the carrier mobility/decrease the carrier resistance and thereby further increase the current injection into the active layer as desired by Itaya.

Art Unit: 2815

## INFORMATION ON HOW TO CONTACT THE USPTO

5. Any inquiry concerning this communication or earlier communications from the examiner should be directed to the examiner, **B. William Baumeister**, at (703) 306-9165. The examiner can normally be reached Monday through Friday, 8:30 a.m. to 5:00 p.m. If the Examiner is not available, the Examiner's supervisor, Mr. Eddie Lee, can be reached at (703) 308-1690. Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the Group receptionist whose telephone number is (703) 308-0956.

B. William Baumeister

Patent Examiner, Art Unit 2815

December 11, 2002